ANKIT KAUL

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EDUCATION

Georgia Institute of Technology, Atlanta, GA   **Ph.D., Electrical and Computer Engineering**, **GPA: 4.0**   *May 2018 – Dec. 2022 (Expected)*

Georgia Institute of Technology, Atlanta, GA   **Master of Science, Electrical and Computer Engineering**, **GPA: 3.65**   *Aug. 2016 – May 2018*
Focus: Digital systems and Computer architecture

Coursework completed: Hardware acceleration for Machine Learning, Interconnection Networks (Network on Chips), Advanced Digital Design with Verilog, Computer Architecture, Advanced VLSI Systems, Digital Systems at Nanometer Nodes.

R.V. College of Engineering, Bangalore, India   **Bachelors, Electrical Engineering, GPA: 9.05/10.0**   *Aug. 2009 – May 2013*

EXPERIENCE

Intern Engineering - Advanced Products, Physical Design Group, arm – Austin, TX   *May 2020 – Aug. 2020*
Project: Optimization of multi-core system specifications for 2.5D ICs.
- Developed a framework to enable exploration of relationship between core implementation targets, DVFS options, thermal limits, and system throughput for multi-core enterprise server systems. **Adviser:** Jim Dodrill (underline)

Graduate Research Assistant, Integrated 3D systems lab, Georgia Institute of technology – Atlanta, GA   *May 2018 – Present*
Modeling thermal coupling and power supply noise effects in 2.5D and polylithic-3D IC systems.
Funding org.: SRC, **Adviser: Dr. Muhannad Bakir** (http://bakirlab.gatech.edu/)

UTC Aerospace Systems, Hardware Engineer – Bangalore, India   *Jul. 2013 – Jul. 2016*
Responsible for board-level circuit performance analysis of an Electronic Control and power quality Monitoring (ECM) unit for Boeing's 777x
Impact: Achieved **$50k savings** by improving ECM circuit performance via analysis of tolerance bottlenecks using Allegro AMS Simulator

RESEARCH PROJECTS

Study of limits on accelerator performance due to DRAM performance degradation – individual   *Jan. 2019 – May 2019*
Characterized temperature-driven bandwidth loss in DRAMs and studied the impact of this loss on the runtime performance of systolic CNN hardware accelerator configurations (evaluation tool: **SCALE-SIM systolic CNN accelerator simulator**)
- Established that ~12% temperature-driven DRAM BW loss leads to up to 50% increase in runtime for considered MLPerf DNN workloads
(**Report**: https://www.dropbox.com/s/jprs23jbmr3kh9c/Kaul_ece8893_final_report.pdf?dl=0)

Achieving High-Radix Topology Performance using SMART Networks – individual   *Jan. 2018 – May 2018*
Proposed a design with multiple SMART (Single-Cycle Multihop Asynchronous Repeated Traversal) Network-on-Chip (NoC) mesh networks in parallel to achieve saturation throughput comparable to high-radix topologies (evaluation tool: **Garnet 2.0 NoC architecture simulator**)
- Demonstrated higher theoretical throughput of a SMART mesh over fbfly variants for heterogeneous traffic with 64 routers
(**Report**: https://www.dropbox.com/s/v5bvtq33uehfn3s/CS8803-Report_Kaul.pdf?dl=0)

PUBLICATIONS

1. **A. Kaul**, S. K. Rajan, M. O. Hossen, G. S. May, and M. S. Bakir, "BEOL-Embedded 3D Polylithic Integration: Thermal and Interconnection Considerations," *IEEE Electronic Components and Technology Conf. (ECTC)*, Orlando, FL, May 2020.
2. T. E. Sarvey, **A. Kaul**, S. K. Rajan, A. Dasu, R. Gutala and M. S. Bakir, "Microfluidic Cooling of a 14nm 2.5D FPGA with 3D Printed Manifolds for High Density Computing: Design Considerations, Fabrication, and Electrical Characterization," in *IEEE Transactions on Components, Packaging and Manufacturing Technology*, 2019. (doi: 10.1109/TCPMT.2019.2930481)

TECHNOLOGY SUMMARY

Languages: Matlab, Python, Verilog HDL, C++, shell
Tools: Cadence Celsius, Cadence Virtuoso, ANSYS Mechanical and Fluent, Synopsys VCS, HSPICE, Calibre, Allegro PCB
Skills: Finite difference techniques for modelling thermal and power delivery network in advanced IC integration, vector-based power and thermal analysis, computer architecture, unix

ACADEMIC PROJECTS

Systolic array RTL implementation, simulation and synthesis for CNN accelerators – individual (course: H/W for ML)   *Mar. 2019*
Implemented (**Verilog**) a systolic array of processing elements (PE) to demonstrate matrix multiplication using output stationary dataflow
- Performed functional verification (**DVE**) and estimated area and power (**Design Compiler**)
- Synthesized design using Nangate 15nm targeting 1GHz, and reported 9.217 mW at an area of 11809 um^2 for an 8x8 array of PEs

Simulation and Performance Analysis of Caches – individual   *Jul. 2017 – Aug. 2017*
Investigated effect of cache configurations on performance by designing a cache simulator to measure latencies and read/write miss rates
- Determined optimal cache parameters such as cache and block size, associativity to achieve minimum AMAT (**C++, shell**)

A 3 stage Pipelined Memory and Arithmetic Unit (45nm) – 4-member team   *Sep. 2016 – Dec. 2016*
Implemented backend design of a 64-byte 6T SRAM Array, driver circuit for a 150fF interconnect, and a 16-bit carry look-ahead adder
- Achieved 1.9x target frequency (1.9GHz) at 0.8V consuming 471 uW (Design: **Virtuoso, Spectre**)